

## PARA LIGHT ELECTRONICS CO., LTD.

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# DATA SHEET

PART NO.: L-C19DLBCT-XG-U1

REV: <u>A/1</u>

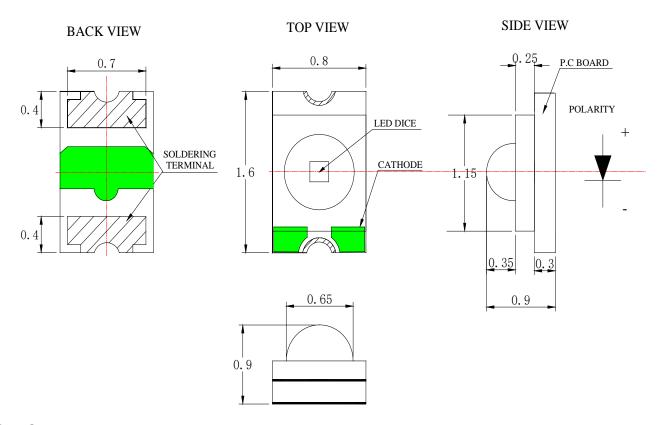
CUSTOMER'S APPROVAL : \_\_\_\_\_ DCC : \_\_\_\_\_



## L-C19DLBCT-XG-U1

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#### PACKAGE DIMENSIONS



#### NOTES:

- 1.All dimensions are in millimeters
- 2.Tolerances are ±0.2mm unless otherwise noted
- 3. The Specifications in the datasheet are subject to change without notice.



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#### **FEATURES**

Dimension (L / w / h): 1.6 x 0.8 x 0.9 mm

Color: blue light

Colloid: transparent spherical colloid

EIA standard packaging

Environmental protection products meet ROHS requirements

Suitable for automatic placement machine Suitable for infrared reflow soldering process

### ABSOLUTE MAXIMUM RATING : ( Ta = 25℃ )

Symbol	Parameter	Rating	Unit		
PD	Power consumption	80	mW		
lf	Forward Current	20	mA		
lfp	Peak Forward Current (1/10 duty cycle 0.1ms)	90	mA		
VR	Reverse Voltage	5	V		
ESD	Electrostatic discharge (HBM)	1500	V		
Topr	Operating Temperature Range	-30℃ ~ + 85℃	${\mathbb C}$		
Tstg	Storage Temperature Range	-40℃ ~ + 90℃	${\mathbb C}$		
Tsol	Tsol Reflow soldering : 255°C ,10s, Hand soldering : 300°C ,3s				

Note: Pulse width ≤0.1ms, Duty≤1/10

## ELECTRO-OPTICAL CHARACTERISTICS : ( $Ta = 25^{\circ}$ )

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Condition
Luminous Intensity	lv	300	430	530	mcd	IF=20mA
Dominant Wavelength	WD	457	466	470	nm	IF=20mA
Forward Voltage	VF	2.8	3.0	3.2	V	IF=20mA
Reverse Current	IR	-	-	5	μΑ	VR=5V
Viewing Angle	201/2	-	60	-	deg	IF=20mA



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#### Bin Code List

Parameter	Symbol	Min.	Max.	Unit	Test Condition
Luminous Intensity	IV	300	350		IF =20mA
		350	430	mcd	
		430	530		
Forward Voltage	VF	2.8	3.0	V	V IF =20mA
	VF	3.0	3.2	V	
Dominant Wavelength		457	460		IF =20mA
	WD	460	463		
	gth WD	463	466	nm	
		466	470		

### Label marking error:

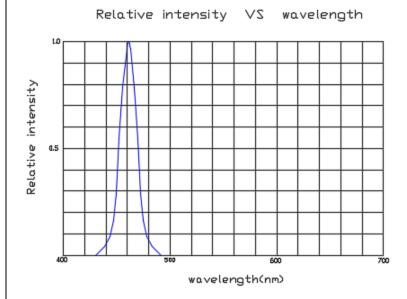
- 1. Tolerance of measurement of luminous intensity is  $\pm 20\%$ .
- 2. Tolerance of measurement of dominant wavelength is  $\pm 2nm$ .
- 3. Tolerance of measurement of Vf is  $\pm 0.1$  V.

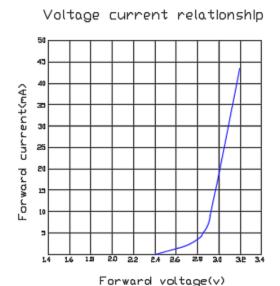


## L-C19DLBCT-XG-U1

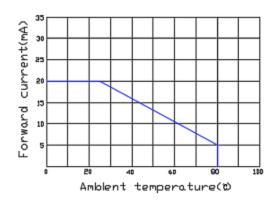
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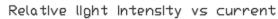
### Typical Electro-Optical Characteristics Curves

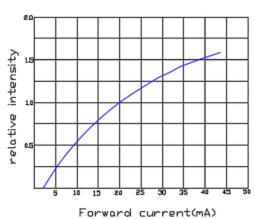


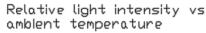


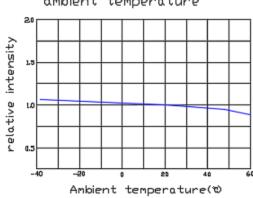
Current and a'mbient temperature



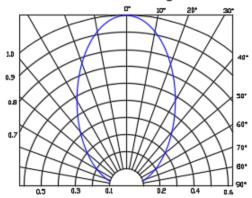








#### Radiation angle

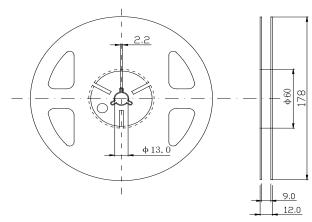




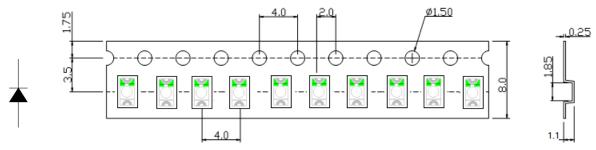
## L-C19DLBCT-XG-U1

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#### **Reel Dimensions**



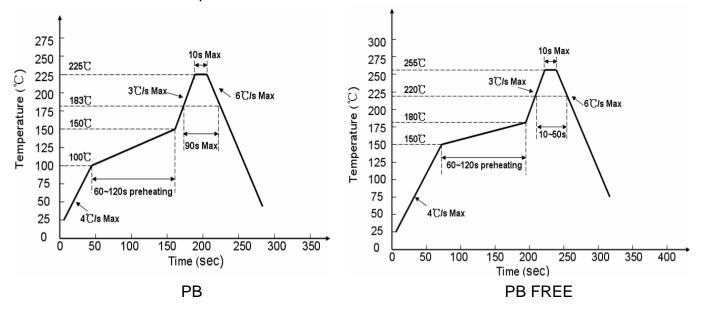
## Package Dimensions Of Tape And Reel



#### Notes:

- 1. Taping Quantity: 4000pcs
- 2. The tolerances unless mentioned is±0.15mm

#### Recommended reflow temperature curve





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### Reliability Test Items And Conditions

Items	Test Condition	Test Hours/Cycles	Quantity	Ac/Re
	1. Reflow soldering maximum temperature = 260 °C, 10			
Moisture proof grade	seconds, twice reflow soldering; 2. Storage condition before reflow soldering: 30 °C, relative humidity = 70%, 168h;	-	22 PCS	0/1
Reliability of welding	Reflow soldering maximum temperature = 245 $\pm$ 5 $^{\circ}$ C, 5	_	22PCS	0/1
(lead free)	seconds (lead free reflow soldering)		221 00	0/1
Thermal cycling	-40 °C 30 min ~ 25 °C 5 min~ 100 °C 30 min ~ 25 °C 5 min	300Cycles	22PCS	0/1
Thermal Shock	L : -35 $^{\circ}$ C 15min. conversion time is 3 minutes H : +85 $^{\circ}$ C 15min.	300Cycles	22PCS	0/1
High Temperature Storage	Temp. : 100℃	1000Hrs	22PCS	0/1
Low Temperature Storage	Temp. : -40℃	1000Hrs	22PCS	0/1
Room temperature aging	Ta=25℃ IF=20mA	1000Hrs	22PCS	0/1

#### Failure Criteria

Took Itama	Cumb of	Took condition	Failure Criteria		
Test Items	Symbol	Test condition	Min.	Max.	
Forward Voltage	VF	IF=20mA		(U.S.L*)×1.1	
Reverse Current	IR	VR=5V		(U.S.L*)×2.0	
Luminous Intensity	lv	IF=20mA	(L.S.L*)×0.7		
Welding reliability	The proportion of solder paste covered pad is less than 95%				

Notes:1.U.S.L means the upper limit of specified characteristics.

2.Measurment shall be taken between 2 hours and after the test pieces have been returned normal ambient conditions after completion of each test.



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#### Cautions

#### Use

High temperature will affect the brightness and other performance of LED, so in order to make LED have better performance, it is necessary to keep led away from heat source.

#### Storage

- 1.Before opening original package, it is recommended to store them in the following environment:Temperature: 5°C~30°C/Humidity: 60%RH max. When inventory exceeds two months,Dehumidification treatment should be done before use at 60 °C for 8 hours;
- 2. After opening original package, the storage ambient for the LEDs should be in 5~30°C temperature and 60% or less relative humidity.
- 3. In order to avoid moisture absorption, it is recommended that the LEDs that out of the original package should be stored in a sealed container with appropriate desiccant, or in desiccators with nitrogen ambient.
- 4. The LEDs should be used within 168hrs (7 days) after opening the package. Once been mounted, soldering should be quick.
- 5. If the moisture absorbent material (silica gel) has faded away or the LEDs stored out of original package for more than 168hrs (7 days), baking treatment should be performed using the conditions: 60°C at least 24 hours.

#### **ESD (Electrostatic Discharge )-Protection**

A LED (especially the Blue. White and Green product) is an ESD sensitive component, and static electricity or power surge will damage the LED. ESD-damaged LEDs will exhibit abnormal characteristics such as high reverse leakage current, low forward voltage, or "no light-up" at low currents, etc.

Some advice as below should be noticed:

- 1. Wear antistatic wristband or gloves when touching led;
- 2. All machines and equipment, tools, work tables, material racks, etc. should be properly grounded (the grounding impedance value is less than 10  $\Omega$ );
- 3. Anti static bag, box and turnover box should be used when storing or handling led, and ordinary plastic products are strictly prohibited;
- 4. It is suggested to use ion fan to restrain static electricity during operation;

#### Cleaning

Use alcohol-based cleaning solvents such as IPA (isopropyl alcohol) to clean LEDs if necessary.



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#### Welding

- 1.Refer to the temperature curve on page 1 for reflow welding conditions;
- 2. The number of reflow soldering shall not exceed two times;
- 3.It is only recommended to use manual welding in the case of repair and heavy work. The maximum welding temperature should not exceed 300 °C and should be completed within 3 seconds.
- 4. The maximum power of soldering iron shall not exceed 30W;
- 5. During welding, it is forbidden to touch colloid at high temperature; after welding, it is forbidden to apply external force on colloid and bend PCB to avoid damage to components to hit.

#### Other

- 1.The definition of LED described in this specification shall be used in the scope of common electronic equipment (such as office equipment, communication equipment, etc.). If there is more severe Especially when the component failure or failure may directly endanger life and health (such as aerospace, transportation, transportation, medical treatment) Equipment, safety protection, etc.), please inform our business personnel in advance;
- 2. When high brightness LED products are on, it may cause damage to human eyes, so it is necessary to avoid looking directly at them from above;
- 3. For the purpose of continuous improvement, product appearance and parameter specifications may be changed without prior notice.